

Parameter	Symbol	Rating	Units	
Load Voltage	VL	60	V	
Load Current	lL .	1.1	Α	
On-Resistance	Ron	0.27	Ω	
On-Resistance	V/ıo	5000	Vrms	









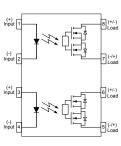
E534710

V_{L2} (AC,DC)



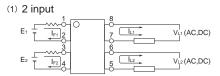
SMD-8

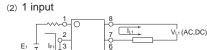




1,3. LED Anode

- 2,4. LED Cathode 5,6. Drain (MOS FET)
- 7,8. Drain (MOS FET)





APSEMI PhotoRelays

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power. While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- · Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

Applications

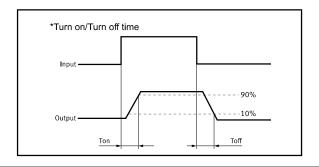
These advantages make APSEI Photorelays the ideal choice for:

- Telecom/Datacom switching
- Multiplexers
- . Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- **Energy Management**
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Category	Output Rating		Pookogo	Part No.	Poolsing Overtity					
	Load Voltage	Load Current	Package	Fait No.	Packing Quantity					
	AC/DC	AC/DC		DIP-8	APW212G1E	1000pcs /tube				
	AC/DC	60V	1100mA	SMD-8	APW212G1FH	1000pcs /reel				





Absolute Maximum Ratings (Ta = 25°C)

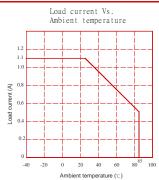
Item		Symbol	Va l ue	Units	Note	
	Continuous LED Current	lF	50	mA		
Input	Peak LED Current	I FP	1000	mA	f=100Hz, duty=1%	
	LED Reverse Voltage	VR	5	V		
	Input Power Dissipation	Pin	75	mW		
	Load Voltage	V∟	60	V(AC peak or DC)		
	Load Current	l.	1.1	А		
Output	Peak Load Current	Peak	2.5	А	100ms(1 pulse)	
	Output Power Dissipation	Pout	450	mW		
Total Power	Dissipation	Р⊤	500	mW		
I/O Breakdown Voltage		V _{I/O}	5000	Vrms	RH=60%, 1min	
Operating Temperature		Торг	-40 to 85	℃		
Storage Temperature		T _{stg}	-40 to 100	℃		
Pin Soldering Temperature		T _{sol}	260	℃	10 sec max.	

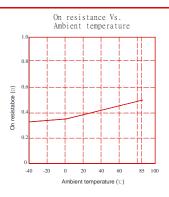
Electrical Characteristics (Ta = 25°C)

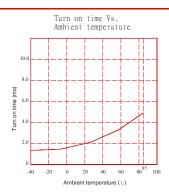
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions	
	LED Forward Voltage	VF		1.2	1.4	V	I⊧=10mA	
	Operation LED Current	Fon		0.5	3.0	mA		
Input	Recovery LED Current	Foff		0.35	0.5	mA		
	Recovery LED Voltage	V _{Foff}	0.5			V		
							I⊧=5mA,I∟=100mA,	
Output	On-Resistance	Ron		0.27	0.7	Ω	Time to flow is within 1 sec.	
	Off-State Leakage	Leak			1	uA	V∟=Rating	
	Current	ILeak						
	Output Capacitance	Cout		115		pF	V∟=0, f=1MHz	
Transmis	Turn-On Time	Ton		1.5	5.0	ms	I⊧=5mA, I∟=100mA,	
sion	Turn-Off Time	Toff		0.05	2.0	ms		
0	I/O Isolation Resistance	R _{I/O}	10 ¹⁰			Ω	DC500V	
Coupled	I/O Capacitance	Ci/o		0.8	1.5	pF	f=1MHz	

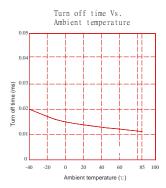


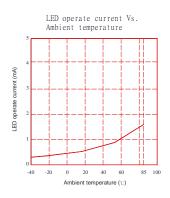
Engineering Data

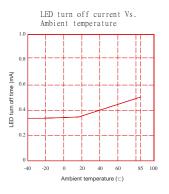


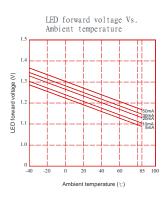


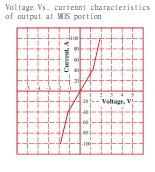


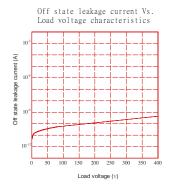


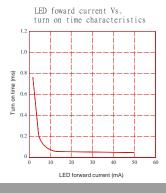


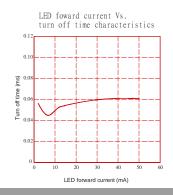


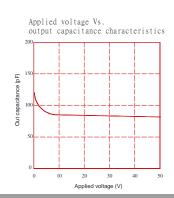








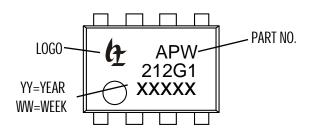






Dimensions and SMD-8 Package Unit: mm

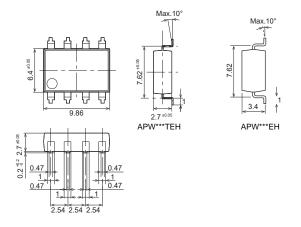
Marking



Lable



Surface mount terminal type

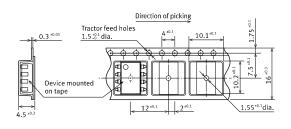


Recommended mounting pad (Top view)

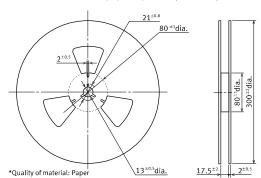


Tape dimensions (tape reel)

Tape dimensions (Unit: mm)



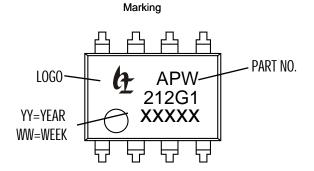
Dimensions of paper tape reel (Unit: mm)





Dimensions and DIP-8 Package

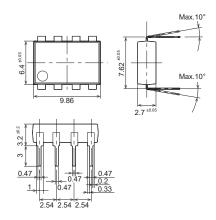
Unit: mm



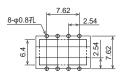
Lable



Through hole terminal type

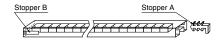


PC board pattern (Bottom view)



DIP Tape dimensions Unit: mm

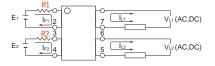
Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.





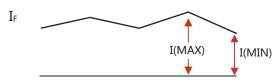
Using Methods

Examples of resistance value to control LED forward current (IF=5mA)



E1 E2	R1 R2(Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9K Ω
24V	4.1K Ω

LED forward current must be more than 5mA, at I(MIN), and less than 30mA, at I(MAX).



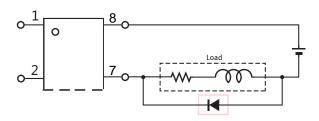
Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

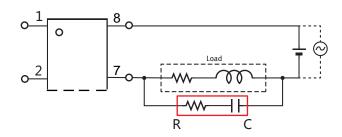
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

Protection Circuit

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.



CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.



When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.



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